

Features

- Floating channel designed for bootstrap operation
- Fully operational to +600 V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout for both channels
- 3.3 V and 5 V input logic compatible
- Matched propagation delay for both channels
- Logic and power ground +/- 5 V offset
- Lower di/dt gate driver for better noise immunity
- Output source/sink current capability (typical) 1.9 A /2.3 A
- Leadfree, RoHS compliant
- Automotive qualified*

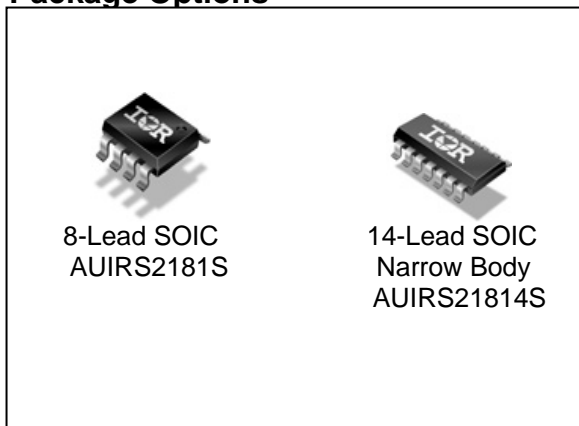
Typical Applications

- Piezo/ common rail Injection
- Starter/Alternator
- Electric Power Steering
- Fan and compressor

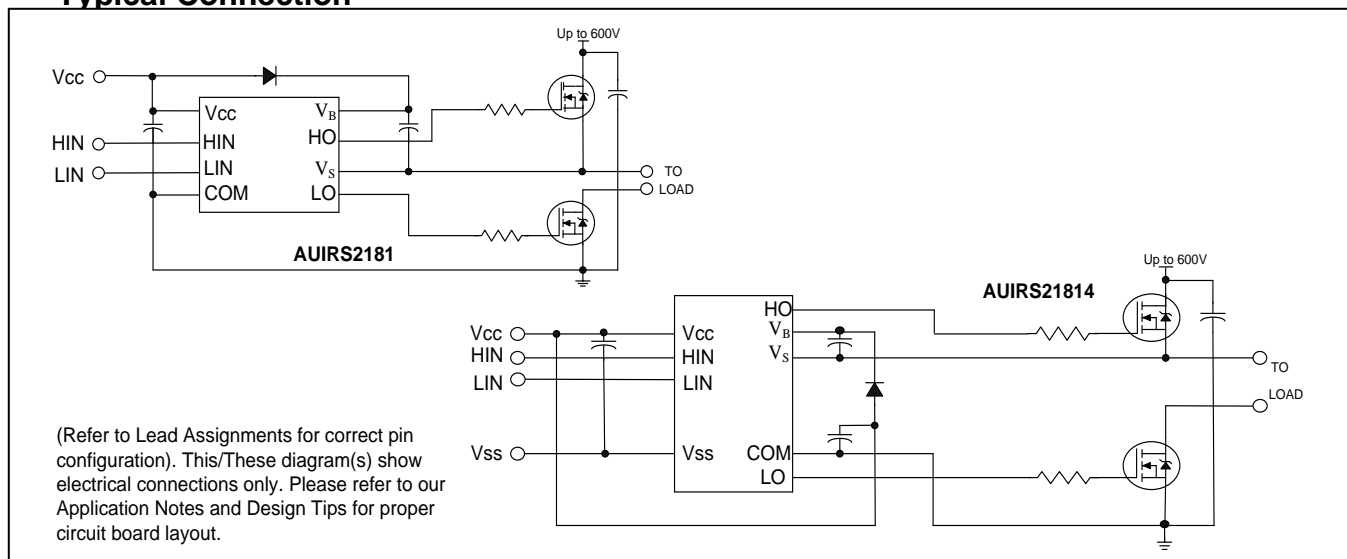
Product Summary

| | |
|--|--------------------------|
| Topology | High and Low Side Driver |
| V _{OFFSET} | ≤ 600 V |
| V _{OUT} | 10 V – 20 V |
| I _{o+} & I _{o-} (typical) | 1.9 A & 2.3 A |
| t _{ON} & t _{OFF} (typical) | 160 ns & 200 ns |

Package Options



Typical Connection



Ordering Information

| Base Part Number | Package Type | Standard Pack | | Complete Part Number |
|------------------|--------------|---------------|----------|----------------------|
| | | Form | Quantity | |
| AUIRS2181S | SOIC8 | Tube/Bulk | 95 | AUIRS2181S |
| | | Tape and Reel | 2500 | AUIRS2181STR |
| AUIRS21814S | SOIC14N | Tube/Bulk | 55 | AUIRS21814S |
| | | Tape and Reel | 2500 | AUIRS21814STR |

Description

The AUIRS2181(4)S are high voltage, high speed power MOSFET and IGBT drivers with independent high and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 600 V.

Feature Comparison: AUIRS2181/AUIRS2183/AUIRS2184

| Part | Input Logic | Cross-Conduction Prevention logic | Dead-Time | Ground Pins | Ton/Toff |
|-------|-------------|-----------------------------------|-------------------------|----------------------|------------|
| 2181 | HIN/LIN | no | none | COM | 160/200 ns |
| 21814 | | | | V _{SS} /COM | |
| 2183 | HIN/LIN | yes | Internal 500ns | COM | 160/200 ns |
| 21834 | | | Programmable 0.4 – 5 us | V _{SS} /COM | |
| 2184 | IN/SD | yes | Internal 500ns | COM | 600/230 ns |
| 21844 | | | Programmable 0.4 – 5 us | V _{SS} /COM | |

Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM lead. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

| Symbol | Definition | Min | Max | Units | |
|------------|---|----------------|-------------------|-------|------|
| V_B | High-side floating absolute voltage | -0.3 | 625 | V | |
| V_S | High-side floating supply offset voltage | $V_B - 25$ | $V_B + 0.3$ | | |
| V_{HO} | High-side floating output voltage | $V_S - 0.3$ | $V_B + 0.3$ | | |
| V_{CC} | Low-side and logic fixed supply voltage | -0.3 | 20 ^(†) | | |
| V_{LO} | Low-side output voltage | -0.3 | $V_{CC} + 0.3$ | | |
| V_{IN} | Logic input voltage (HIN & LIN) | $V_{SS} - 0.3$ | $V_{CC} + 0.3$ | | |
| V_{SS} | Logic ground (AUIRS21814(S) only) | $V_{CC} - 20$ | $V_{CC} + 0.3$ | | |
| dV_S/dt | Allowable offset supply voltage transient | — | 50 | V/ns | |
| P_D | Package power dissipation @ $T_A \leq 25^\circ\text{C}$ | (8 lead SOIC) | — | 0.625 | W |
| | | (14 lead SOIC) | — | 1.0 | |
| R_{thJA} | Thermal resistance, junction to ambient | (8 lead SOIC) | — | 200 | °C/W |
| | | (14 lead SOIC) | — | 120 | |
| T_J | Junction temperature | — | 150 | °C | |
| T_S | Storage temperature | -50 | 150 | | |
| T_L | Lead temperature (soldering, 10 seconds) | — | 300 | | |

† All supplies are fully tested at 25 V and an internal 20 V clamp exists for each supply.

Recommended Operating Conditions

The input/output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset rating are tested with all supplies biased at 15 V differential.

| Symbol | Definition | Min | Max | Units |
|----------|--|-----------------|------------|-------|
| V_B | High-side floating supply absolute voltage | $V_S + 10$ | $V_S + 20$ | V |
| V_S | High-side floating supply offset voltage | ^(††) | 600 | |
| V_{HO} | High-side floating output voltage | V_S | V_B | |
| V_{CC} | Low-side and logic fixed supply voltage | 10 | 20 | |
| V_{LO} | Low-side output voltage | 0 | V_{CC} | |
| V_{IN} | Logic input voltage | V_{SS} | V_{CC} | |
| DT | Programmable deadtime pin voltage | V_{SS} | V_{CC} | |
| V_{SS} | Logic ground | -5 | 5 | |
| T_A | Ambient temperature | -40 | 125 | °C |

†† Logic operational for V_S of -5 V to +600 V. Logic state held for V_S of -5 V to $-V_{BS}$. (Please refer to the Design Tip DT97-3 for more details).

Dynamic Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of $-40^{\circ}\text{C} \leq T_j \leq 125^{\circ}\text{C}$ with bias conditions of V_{BIAS} ($V_{\text{CC}}, V_{\text{BS}}$) = 15 V, $V_{\text{SS}} = \text{COM}$, $C_L = 1000 \text{ pF}$.

| Symbol | Definition | Min | Typ | Max | Units | Test Conditions |
|------------------|-------------------------------------|-----|-----|-----|-------|--|
| t_{on} | Turn-on propagation delay | — | 160 | 270 | ns | $V_S = 0 \text{ V}$ |
| t_{off} | Turn-off propagation delay | — | 200 | 330 | | $V_S = 0 \text{ V}$ or 600 V |
| MT | Delay matching, HS & LS turn-on/off | — | — | 35 | | |
| t_r | Turn-on rise time | — | 15 | 60 | | $V_S = 0 \text{ V}$ |
| t_f | Turn-off fall time | — | 15 | 35 | | |

Static Electrical Characteristics

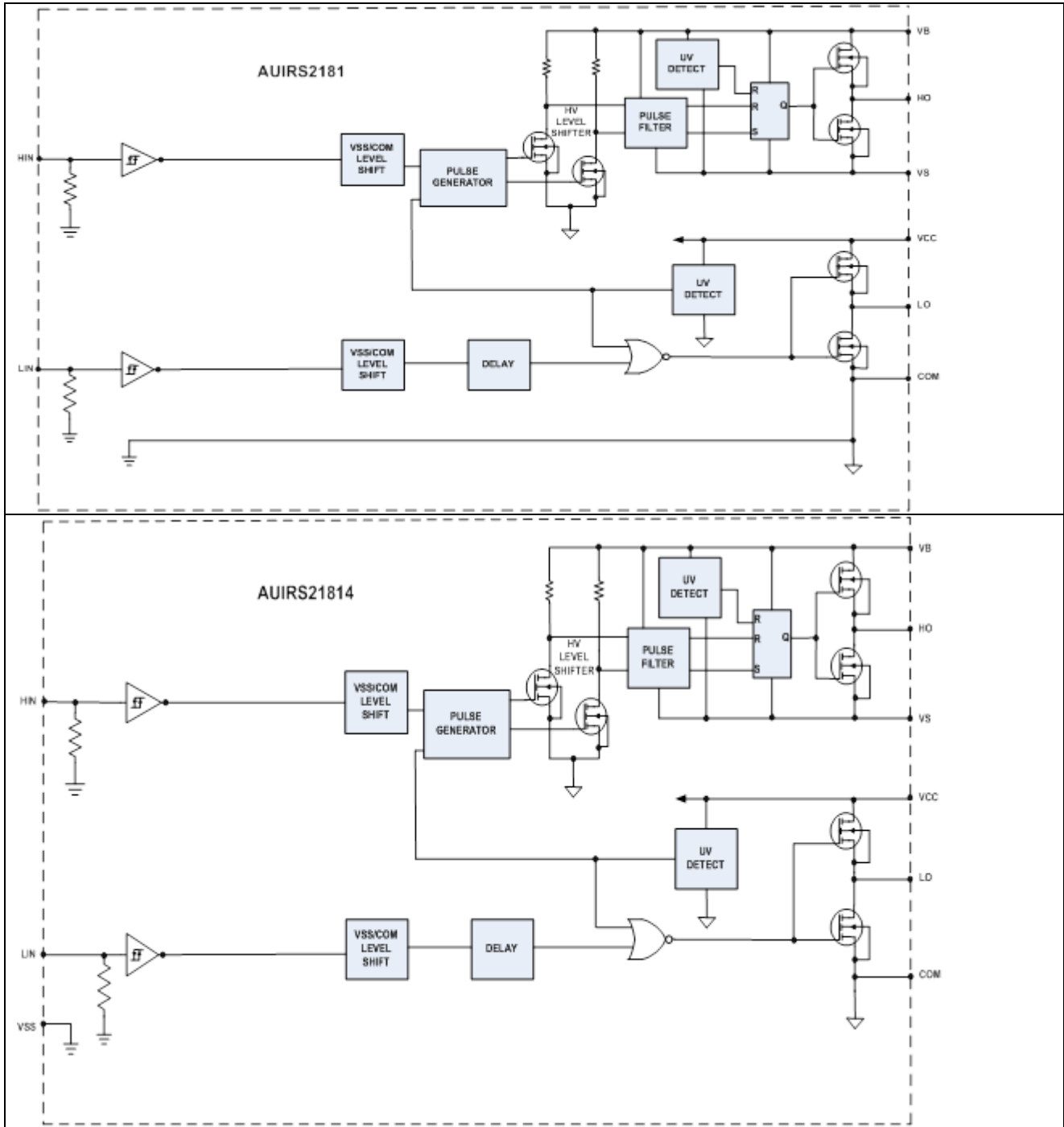
Unless otherwise noted, these specifications apply for an operating junction temperature range of $-40^{\circ}\text{C} \leq T_j \leq 125^{\circ}\text{C}$ with bias conditions of V_{BIAS} ($V_{\text{CC}}, V_{\text{BS}}$) = 15 V, $V_{\text{SS}} = \text{COM}$. The V_{IL} , V_{IH} and I_{IN} parameters are referenced to V_{SS}/COM and are applicable to the respective input leads: HIN and LIN. The V_{O} , I_{O} and R_{on} parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

| Symbol | Definition | Min | Typ | Max | Units | Test Conditions |
|--|--|-----|-----|-----|---------------|--|
| V_{IH} | Logic "1" input voltage | 2.5 | — | — | V | $V_{\text{CC}} = 10 \text{ V}$ to 20 V |
| V_{IL} | Logic "0" input voltage | — | — | 0.8 | | $V_{\text{CC}} = 10 \text{ V}$ to 20 V |
| V_{OH} | High level output voltage, $V_{\text{BIAS}} - V_{\text{O}}$ | — | — | 1.4 | | $I_{\text{O}} = 0 \text{ mA}$ |
| V_{OL} | Low level output voltage, V_{O} | — | — | 0.2 | | $I_{\text{O}} = 20 \text{ mA}$ |
| I_{LK} | Offset supply leakage current | — | — | 50 | μA | $V_{\text{B}} = V_{\text{S}} = 600 \text{ V}$ |
| I_{QBS} | Quiescent V_{BS} supply current | 15 | 60 | 150 | | $V_{\text{IN}} = 0 \text{ V}$ or 5 V |
| I_{QCC} | Quiescent V_{CC} supply current | 15 | 120 | 240 | | $V_{\text{IN}} = 5 \text{ V}$ |
| $I_{\text{IN+}}$ | Logic "1" input bias current | — | 25 | 60 | | $V_{\text{IN}} = 0 \text{ V}$ |
| $I_{\text{IN-}}$ | Logic "0" input bias current | — | — | 5.0 | | |
| $V_{\text{CCUV+}}$ $V_{\text{BSUV+}}$ | V_{CC} and V_{BS} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | V | |
| $V_{\text{CCUV-}}$ $V_{\text{BSUV-}}$ | V_{CC} and V_{BS} supply undervoltage negative going threshold | 7.4 | 8.2 | 9.0 | | |
| V_{CCUVH} V_{BSUVH} | V_{CC} and V_{BS} supply undervoltage Hysteresis | 0.3 | 0.7 | — | | |
| $I_{\text{O25+}}^{(\dagger)}$ | Output high short circuit pulsed current | 1.4 | 1.9 | — | A | $V_{\text{O}} = 0 \text{ V}$, $\text{PW} \leq 10 \mu\text{s}$, $T_j = 25^{\circ}\text{C}$ |
| $I_{\text{O25-}}^{(\dagger)}$ | Output low short circuit pulsed current | 1.8 | 2.3 | — | | $V_{\text{O}} = 15 \text{ V}$, $\text{PW} \leq 10 \mu\text{s}$, $T_j = 25^{\circ}\text{C}$ |
| $I_{\text{O+}}^{(\dagger)(\ddagger)}$ | Output high short circuit pulsed current | 1.2 | — | — | | $V_{\text{O}} = 0 \text{ V}$, $\text{PW} \leq 10 \mu\text{s}$ |
| $I_{\text{O-}}^{(\dagger)(\ddagger)}$ | Output low short circuit pulsed current | 1.5 | — | — | | $V_{\text{O}} = 15 \text{ V}$, $\text{PW} \leq 10 \mu\text{s}$ |

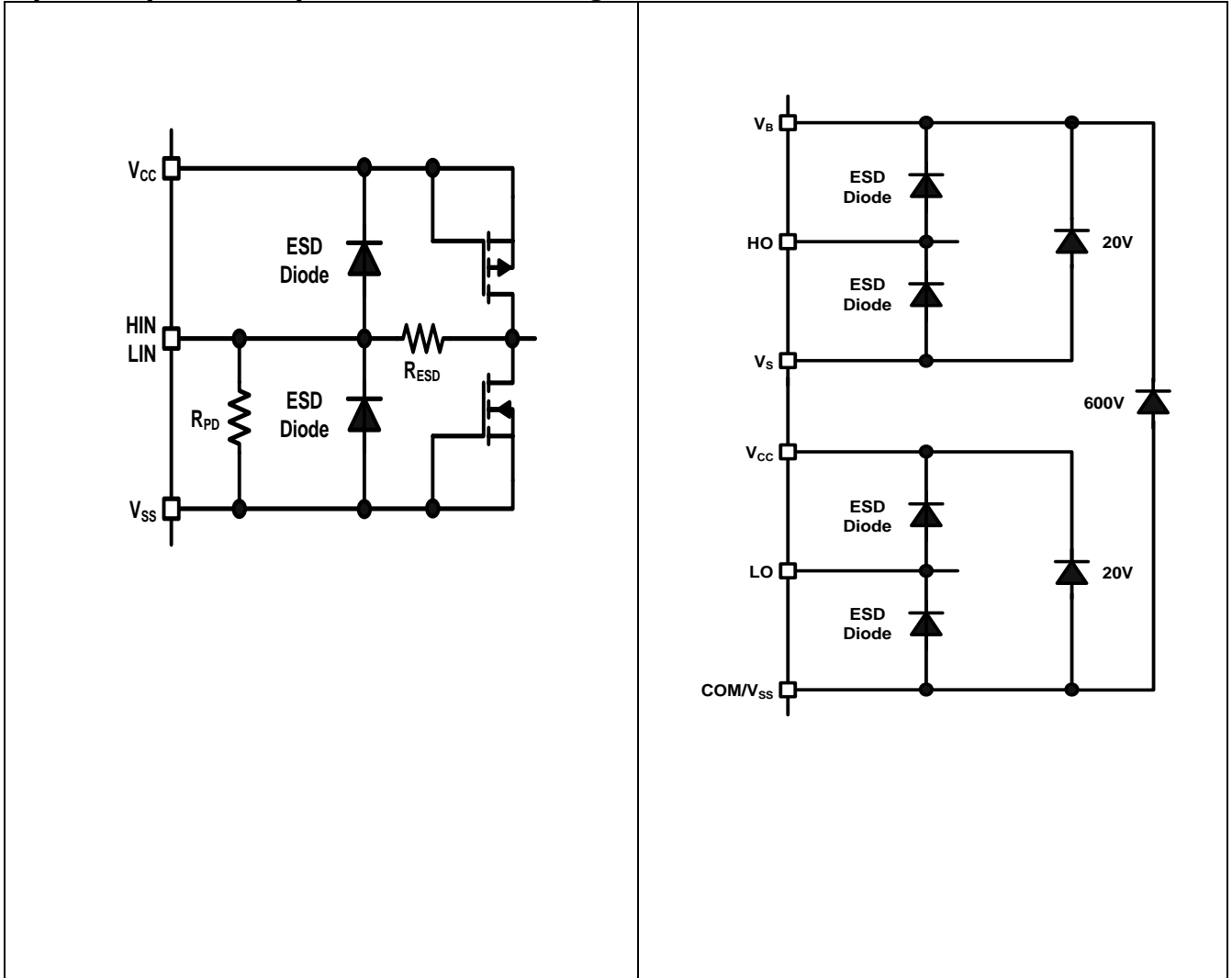
(†) Guaranteed by design

(‡) $I_{\text{O+}}$ and $I_{\text{O-}}$ decrease with rising temperature

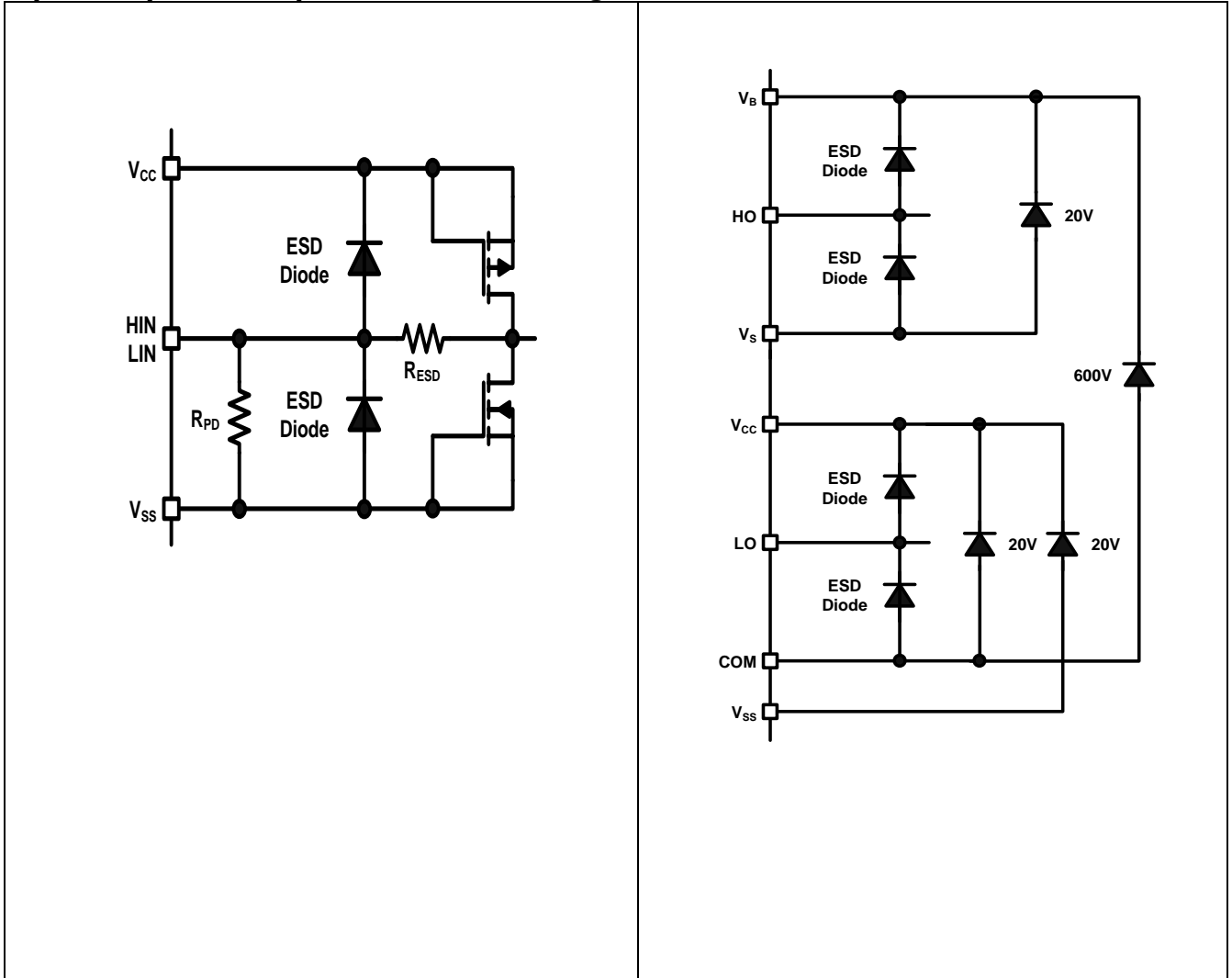
Functional Block Diagrams: AUIRS2181, AUIRS21814



Input/Output Pin Equivalent Circuit Diagrams: AUIRS2181S



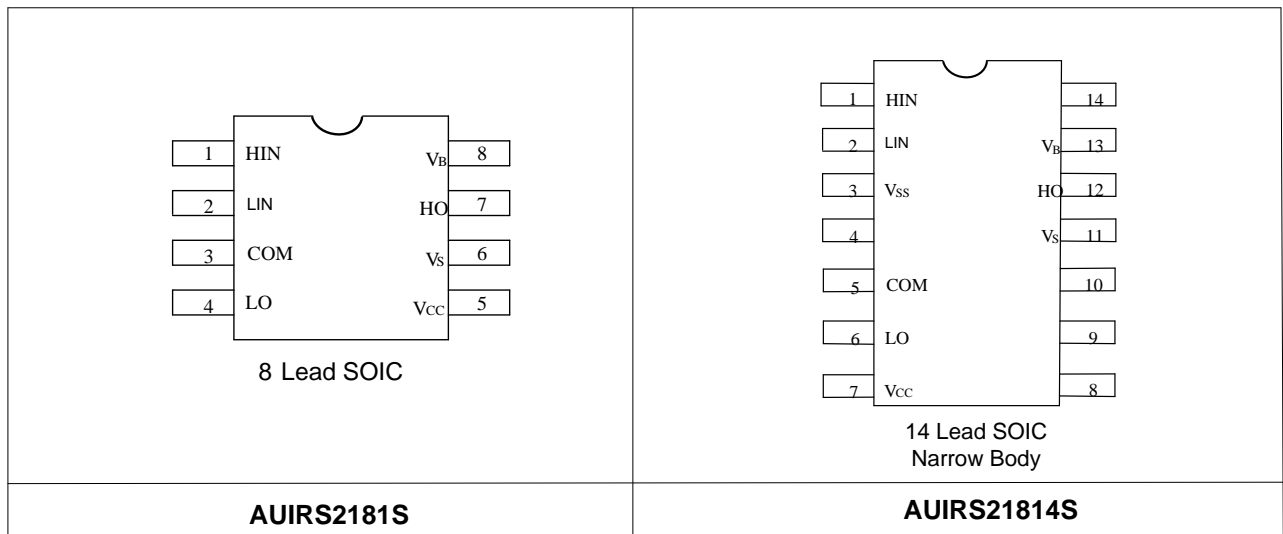
Input/Output Pin Equivalent Circuit Diagrams: AUIRS21814S



Lead Definitions: AUIRS2181(4)S

| Symbol | Description |
|-----------------|---|
| HIN | Logic input for high-side gate driver output (HO), in phase |
| LIN | Logic input for low-side driver output (LO), in phase |
| V _{SS} | Logic ground (AUIRS21814 only) |
| V _B | High-side floating supply |
| HO | High-side gate drive output |
| V _S | High-side floating supply return |
| V _{CC} | Low-side and logic fixed supply |
| LO | Low-side gate drive output |
| COM | Low-side return |

Lead Assignments: AUIRS2181(4)S



Application Information and Additional Details

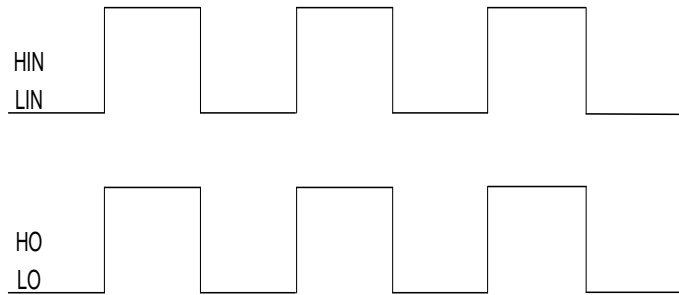


Figure 1. Input/Output Timing Diagram

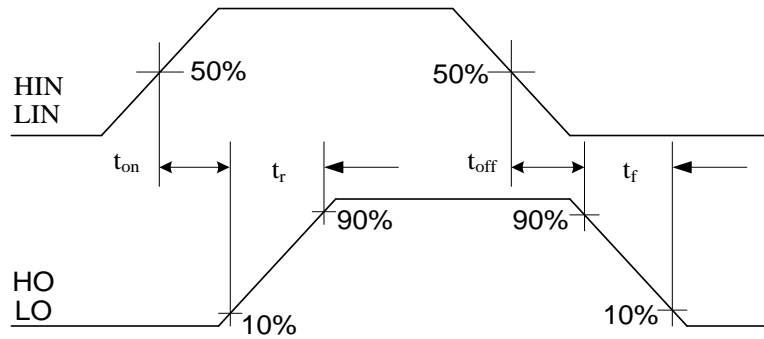


Figure 2. Switching Time Waveform Definitions

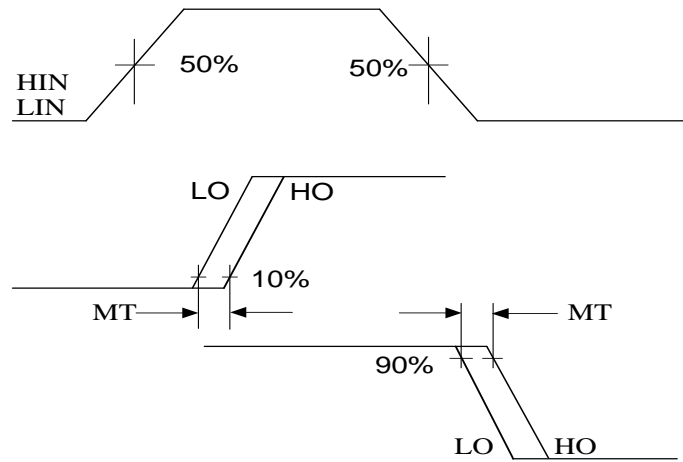


Figure 3. Delay Matching Waveform Definitions

Parameter Trends vs. Temperature and vs. Supply Voltage

Figures of this chapter provide information on the experimental performance of the AUIRS2181(4)S HVIC. The line plotted in each figure is generated from actual lab data.

A large number of individual samples were tested at three temperatures (-40 °C, 25 °C, and 125 °C) in order to generate the experimental curve. The line consists of three data points (one data point at each of the tested temperatures) that have been connected together to illustrate the understood trend. The individual data points on the Typ. curve were determined by calculating the averaged experimental value of the parameter (for a given temperature).

A different set of individual samples was used to generate curves of parameter trends vs. supply voltage.

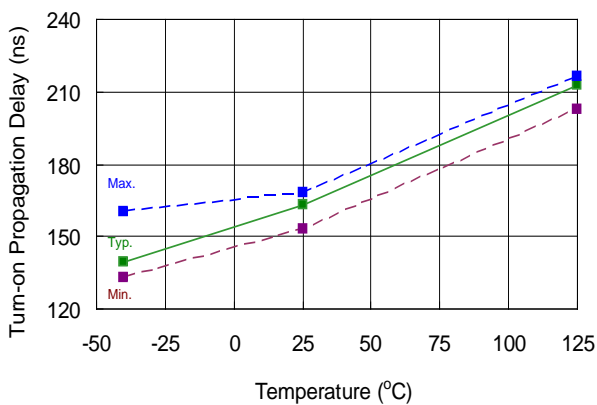


Figure 1A. Turn-On Propagation Delay vs. Temperature

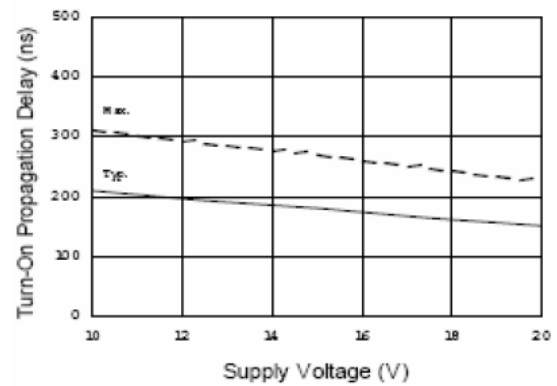


Figure 1B. Turn-On Propagation Delay vs. Supply Voltage

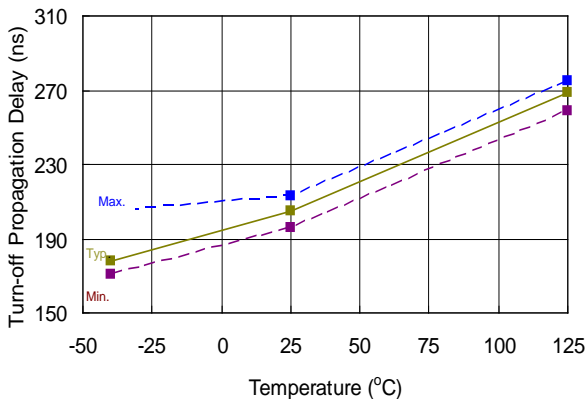


Figure 2A. Turn-Off Propagation Delay vs. Temperature

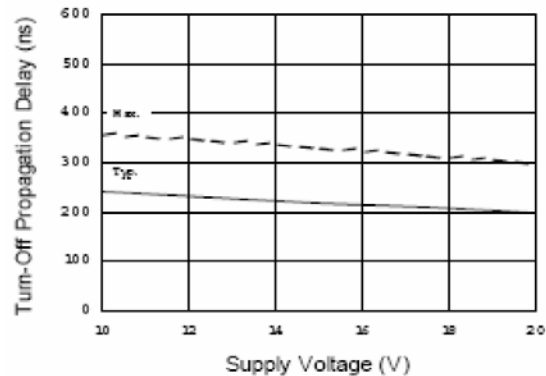


Figure 2B. Turn-Off Propagation Delay vs. Supply Voltage

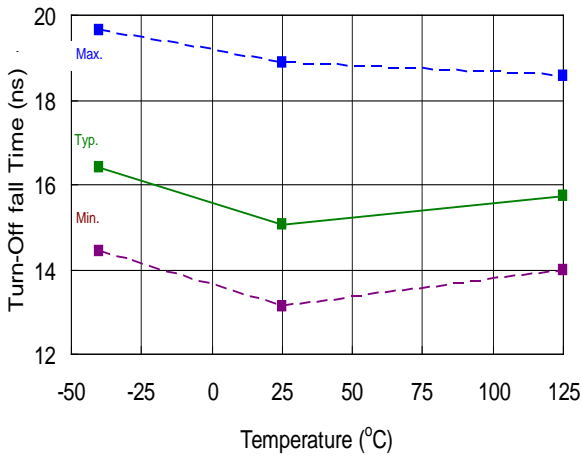


Figure 3A. Turn-Off Fall Time vs. Temperature

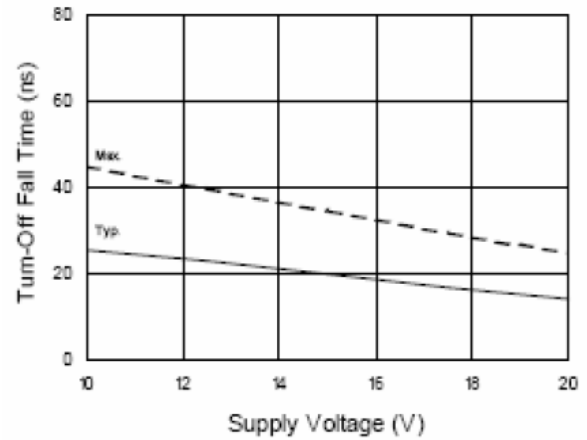


Figure 3B. Turn-Off Fall Time vs. Supply Voltage

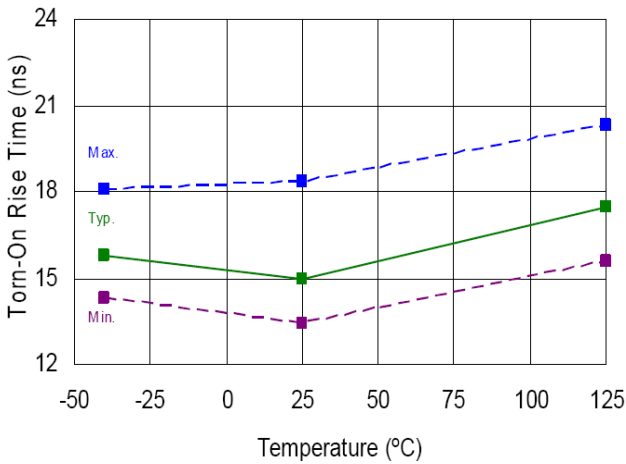


Figure 4. Turn-On Rise Time vs. Temperature

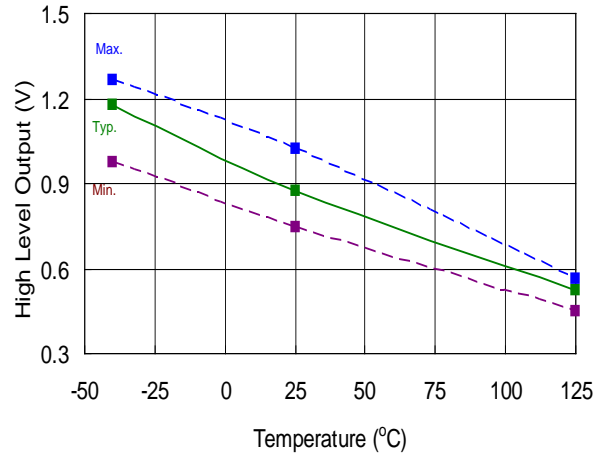


Figure 5. High Level Output Voltage vs. Temperature (Io = 0mA)

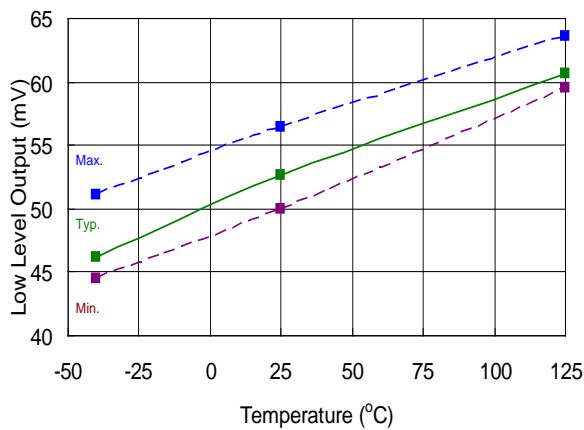


Figure 6. Low Level Output vs. Temperature

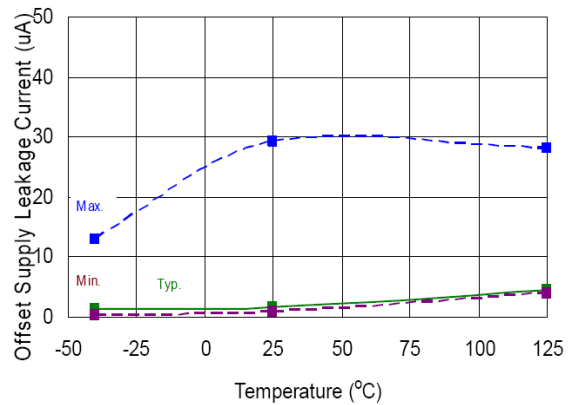


Figure 7. Offset Supply Leakage Current vs. Temperature

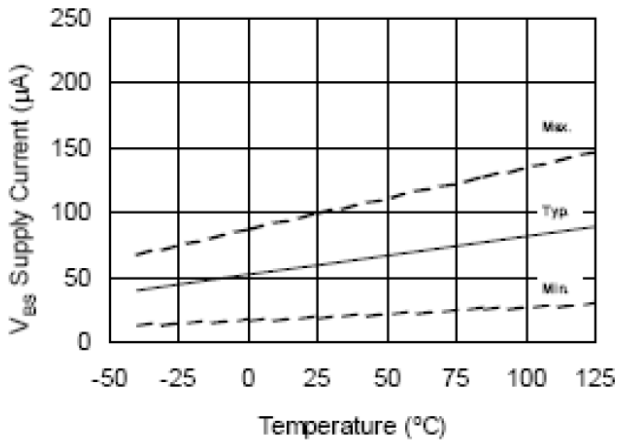


Figure 8A V_{BS} Supply Current vs. Temperature

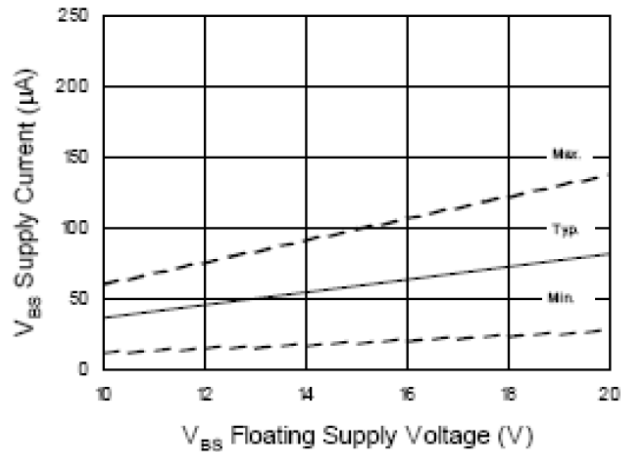


Figure 8B V_{BS} Supply Current vs. V_{BS} Floating Supply Voltage

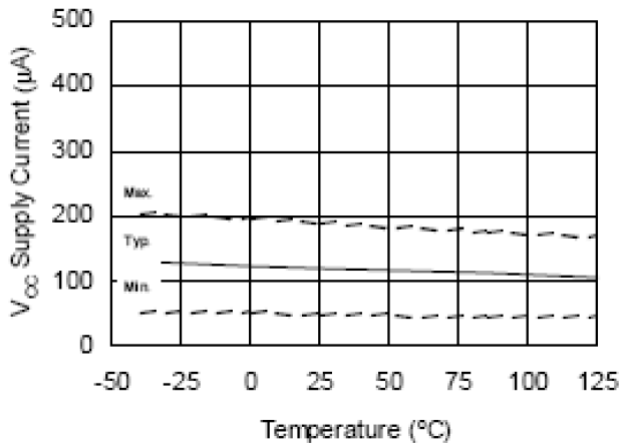


Figure 9A V_{CC} Supply Current vs. Temperature

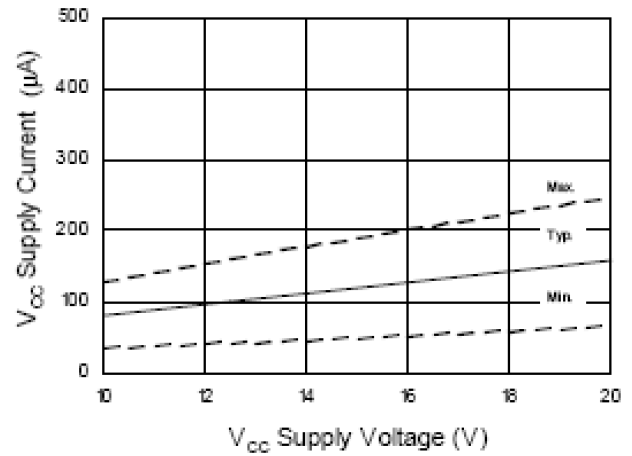


Figure 9B V_{CC} Supply Current vs. V_{CC} Supply Voltage

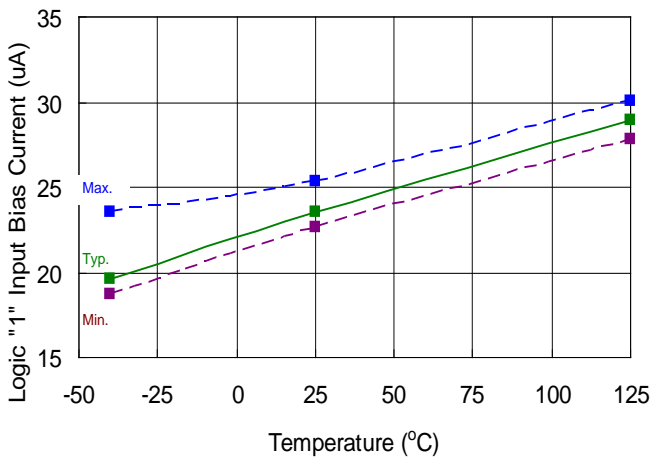


Figure 10. Logic "1" Input Bias vs. Temperature

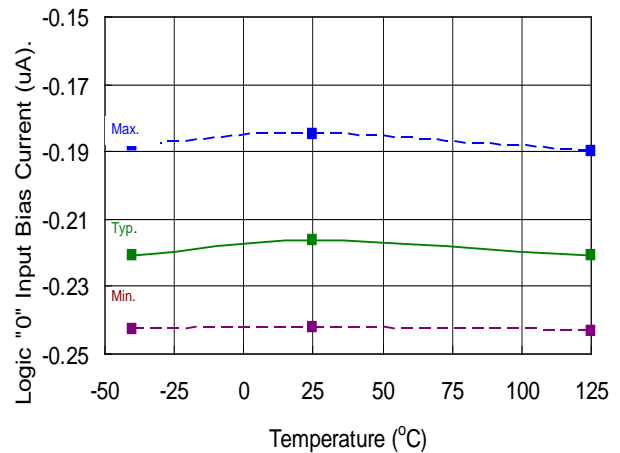


Figure 11. Logic "0" Input Bias vs. Temperature

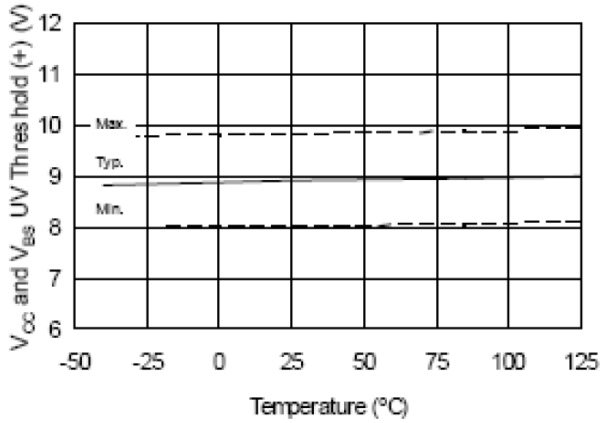


Figure 12. V_{CC} and V_{BS} Undervoltage Threshold(+) vs Temperature

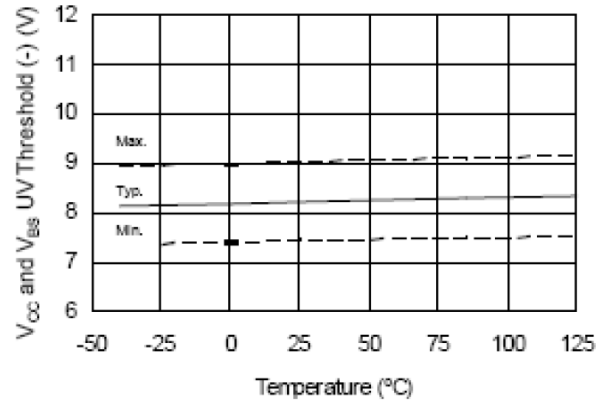


Figure 13. V_{CC} and V_{BS} Undervoltage Threshold(-) vs Temperature

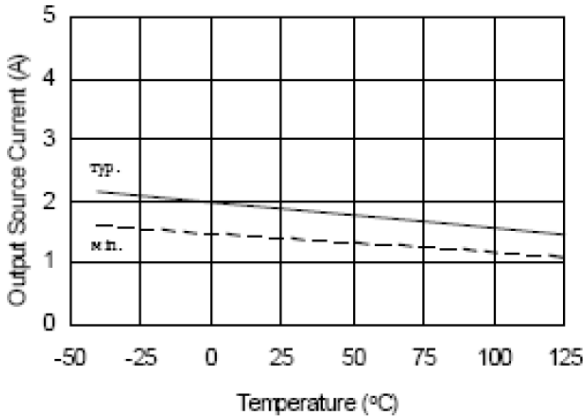


Figure 14A. Output Source Current vs Temperature

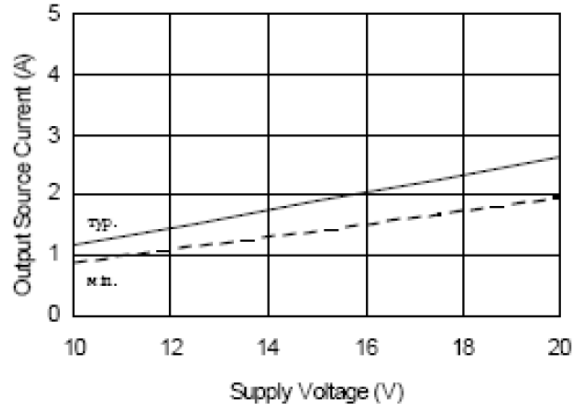


Figure 14B. Output Source Current vs Supply Voltage

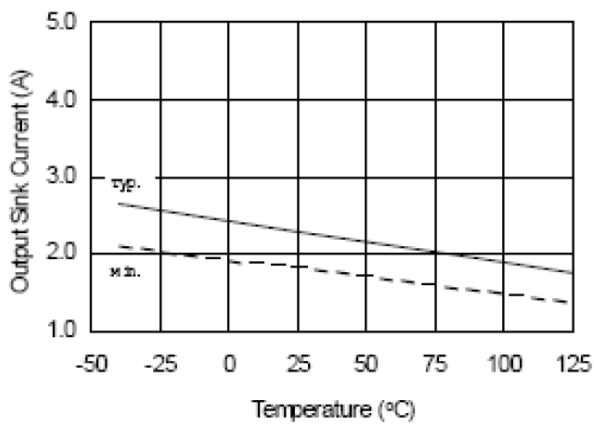


Figure 15A. Output Sink Current vs Temperature

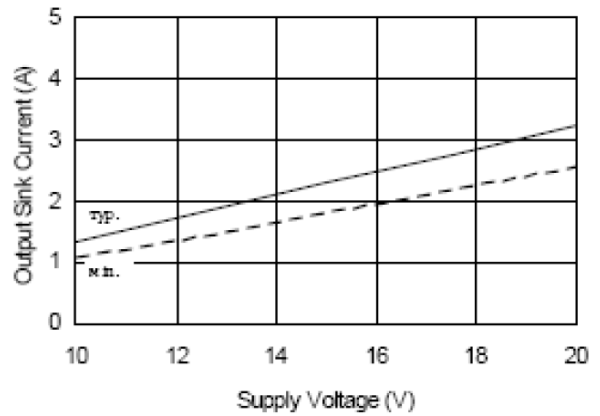


Figure 15B. Output Sink Current vs Supply Voltage

Negative Vs Safety Operating Area (negVs SOA)

There could be conditions in which Vs node falls below (i.e. negative) VSS/COM nodes (e.g. because of wrong system layout). This condition should be avoided because it could bring to uncontrolled behavior of the driver.

The negVs SOA identifies the energy of negative Vs pulses at which the driver can withstand; pulse energy is identified as the product of pulse duration by its amplitude. Fig. 16 shows the negVs SOA of AUIRS2181(4)S at both ambient and over temperature conditions. Test conditions were VCC=VBS=15V referenced to VSS=COM.

Even though the AUIRS2181(4)S has been designed and tested to handle these negative VS transient conditions, it is highly recommended that the circuit designer always limit the negative VS transients as much as possible by careful PCB layout and component use.

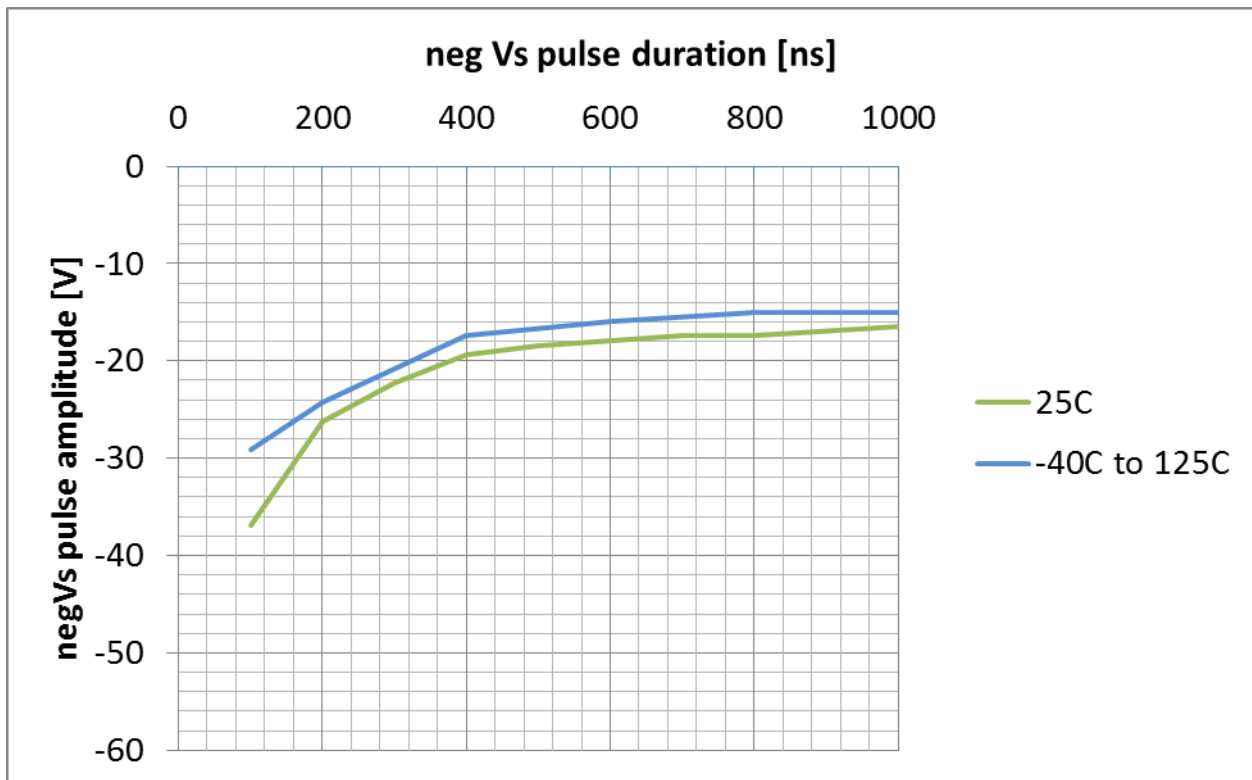
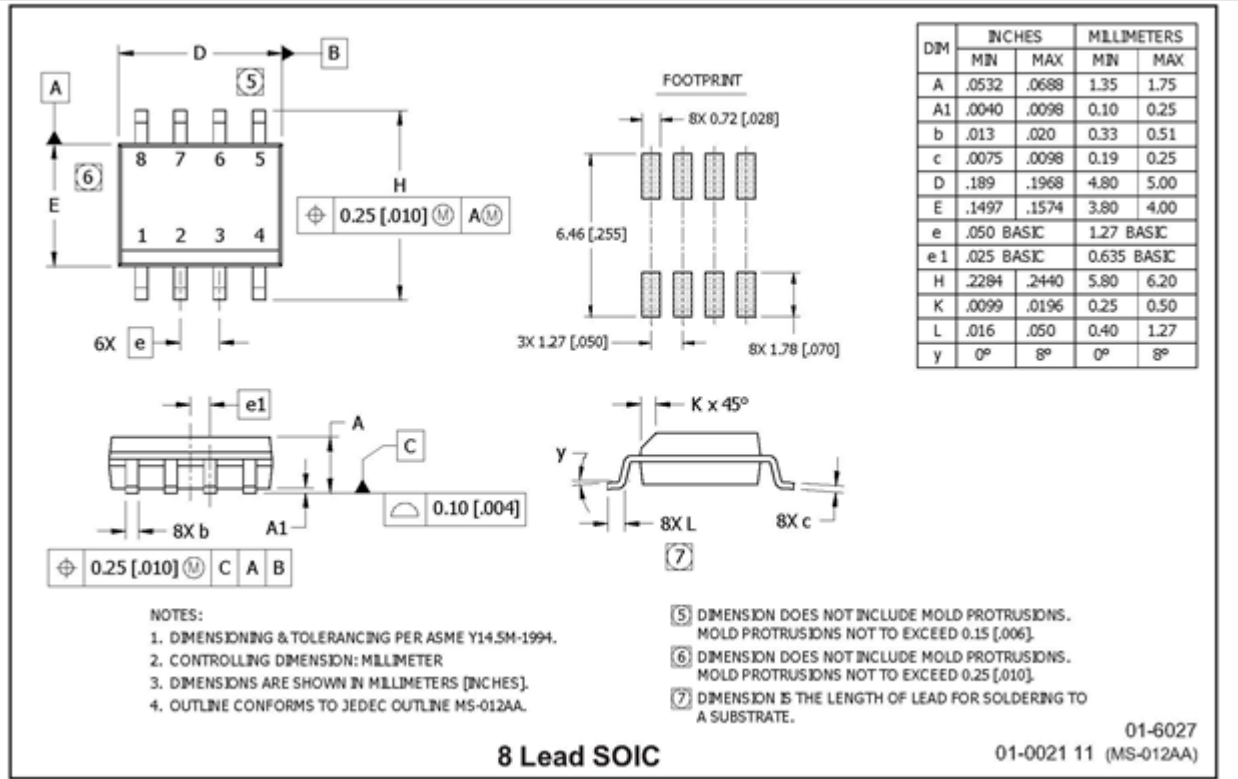
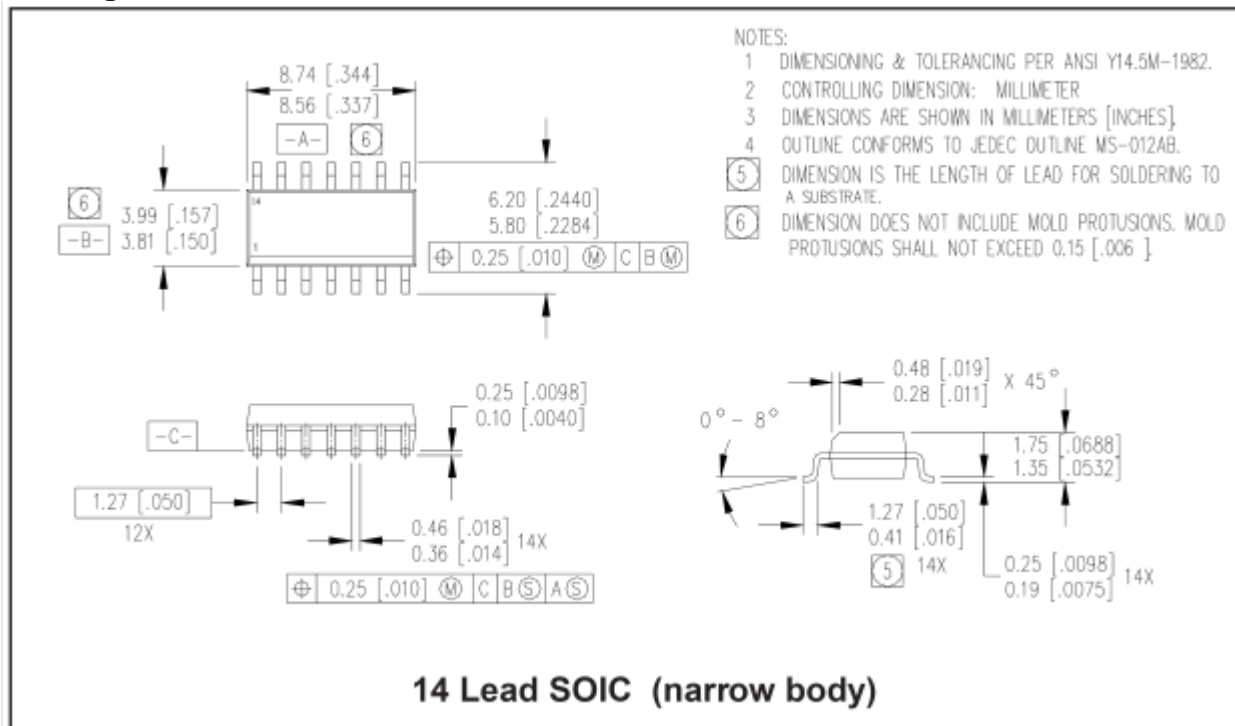
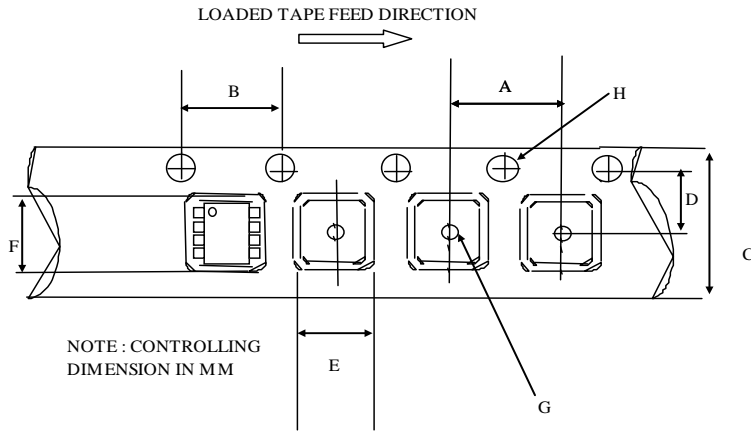


Fig. 16 Negative Vs SOA of AUIRS2181(4)S.

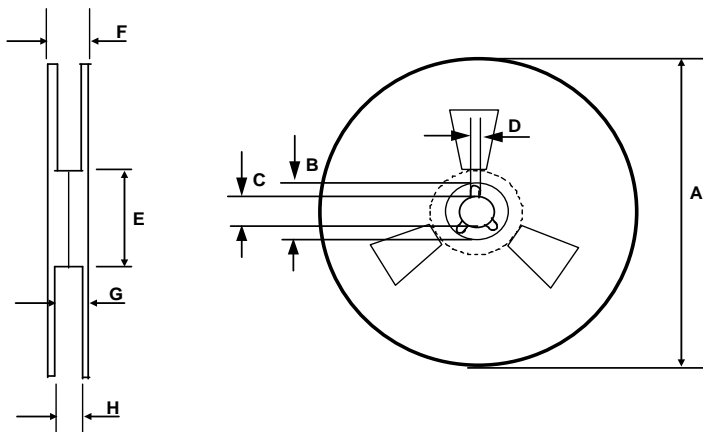
Package Details: SOIC8

Package Details: SOIC14N


Tape and Reel Details: SOIC8



CARRIER TAPE DIMENSION FOR 8SOICN

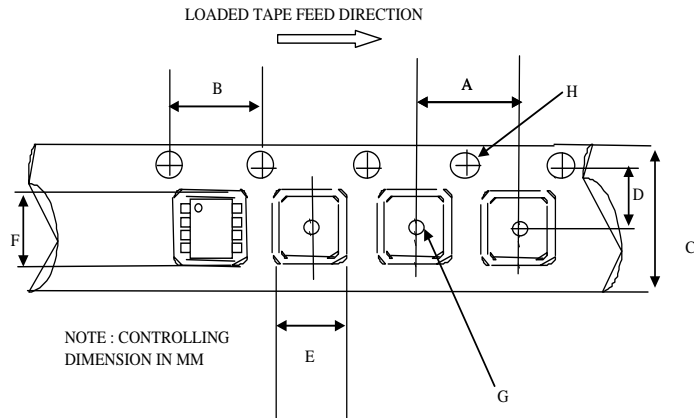
| Code | Metric | | Imperial | |
|------|--------|-------|----------|-------|
| | Min | Max | Min | Max |
| A | 7.90 | 8.10 | 0.311 | 0.318 |
| B | 3.90 | 4.10 | 0.153 | 0.161 |
| C | 11.70 | 12.30 | 0.46 | 0.484 |
| D | 5.45 | 5.55 | 0.214 | 0.218 |
| E | 6.30 | 6.50 | 0.248 | 0.255 |
| F | 5.10 | 5.30 | 0.200 | 0.208 |
| G | 1.50 | n/a | 0.059 | n/a |
| H | 1.50 | 1.60 | 0.059 | 0.062 |



REEL DIMENSIONS FOR 8SOICN

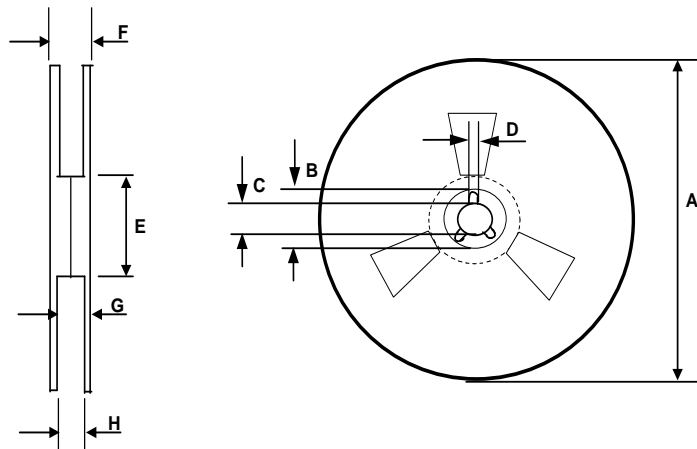
| Code | Metric | | Imperial | |
|------|--------|--------|----------|--------|
| | Min | Max | Min | Max |
| A | 329.60 | 330.25 | 12.976 | 13.001 |
| B | 20.95 | 21.45 | 0.824 | 0.844 |
| C | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| E | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 18.40 | n/a | 0.724 |
| G | 14.50 | 17.10 | 0.570 | 0.673 |
| H | 12.40 | 14.40 | 0.488 | 0.566 |

Tape and Reel Details: SOIC14N



CARRIER TAPE DIMENSION FOR 14SOICN

| Code | Metric | | Imperial | |
|------|--------|-------|----------|-------|
| | Min | Max | Min | Max |
| A | 7.90 | 8.10 | 0.311 | 0.318 |
| B | 3.90 | 4.10 | 0.153 | 0.161 |
| C | 15.70 | 16.30 | 0.618 | 0.641 |
| D | 7.40 | 7.60 | 0.291 | 0.299 |
| E | 6.40 | 6.60 | 0.252 | 0.260 |
| F | 9.40 | 9.60 | 0.370 | 0.378 |
| G | 1.50 | n/a | 0.059 | n/a |
| H | 1.50 | 1.60 | 0.059 | 0.062 |

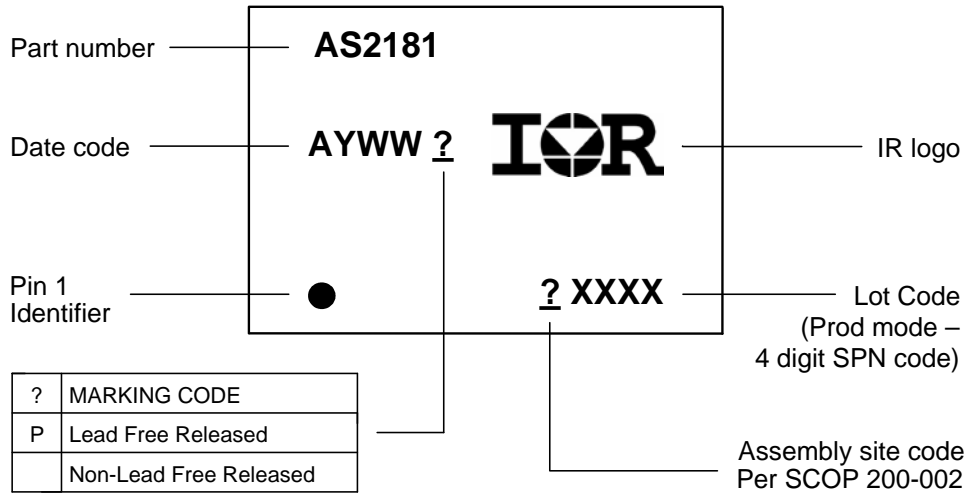


REEL DIMENSIONS FOR 14SOICN

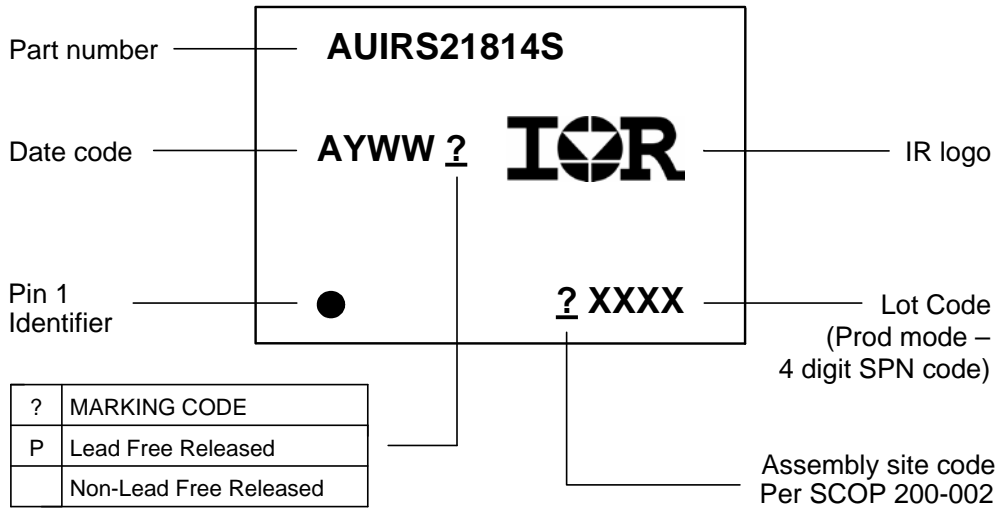
| Code | Metric | | Imperial | |
|------|--------|--------|----------|--------|
| | Min | Max | Min | Max |
| A | 329.60 | 330.25 | 12.976 | 13.001 |
| B | 20.95 | 21.45 | 0.824 | 0.844 |
| C | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| E | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 22.40 | n/a | 0.881 |
| G | 18.50 | 21.10 | 0.728 | 0.830 |
| H | 16.40 | 18.40 | 0.645 | 0.724 |

Part Marking Information

SOIC8:



SOIC14N:



Qualification Information[†]

| | | | |
|-----------------------------------|-----------------------------|---|--|
| Qualification Level | | Automotive (per AEC-Q100 ^{††}) | |
| | | Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level. | |
| Moisture Sensitivity Level | | SOIC8 | MSL3 ^{†††} 260°C (per IPC/JEDEC J-STD-020) |
| | | SOIC14N | MSL3 ^{†††} 260°C (per IPC/JEDEC J-STD-020) |
| ESD | <i>Machine Model</i> | Class M2 (Pass +/-150V) (per AEC-Q100-003) | |
| | <i>Human Body Model</i> | Class H1B (Pass +/-1000V) (per AEC-Q100-002) | |
| | <i>Charged Device Model</i> | Class C4 (Pass +/-1000V) (per AEC-Q100-011) | |
| IC Latch-Up Test | | Class II, Level A ^{††††} (per AEC-Q100-004) | |
| RoHS Compliant | | Yes | |

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Exceptions to AEC-Q100 requirements are noted in the qualification report.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

†††† HIN, LIN Class II Level B at 80mA per JESD78.

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For technical support, please contact IR’s Technical Assistance Center

<http://www.irf.com/technical-info/>

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Tel: (310) 252-7105

Revision History

| Date | Comment |
|-------------------------------|---|
| 04/29/08 | Draft |
| 5/6/08 | Converted to new automotive format |
| 9/30/08 | Reviewed and updated various missing information |
| 10/01/08 | Inserted Input/Output Pin Equivalent Circuit Diagram |
| Feb, 10 th , 2009 | Typ application list and other minor changes |
| Feb. 11, 2009 | Removed PDIP package versions from datasheet |
| Aug. 4, 2009 | Updated qualification information, characterization curves |
| Aug. 11, 2009 | Updated plot, removed characterization graphs, changes package type info |
| Aug. 13, 2009 | Updated VIH/VIL graphs |
| Sep 23 rd , 2009 | Typ appl. Section update; Rearranged graphs with temperature and supply characteristic, updated marking detail with p/n; added ESD passing voltage; update LU test passing current from 40mA to 80mA. |
| Dec. 16, 09 | Changed Iqcc/Iqbs min to 15uA; added Important Notice page; changed ton typ=160ns; toff typ=200ns; tr typ=15ns; tf typ=15ns |
| Feb. 24, 2010 | Page 6: Added I _{O25+} and I _{O25-} specification and the notes |
| Jul. 27, 2010 | clamp diode values changed from 25V into 20V (in-out pin eq. circ. diagrams) |
| Mar 07, 2012 | Input zener clamp note deleted in recommended op cond |
| Sept. 30 th , 2013 | Added negVs SOA |
| Oct. 04 th , 2013 | Adapted to new format |
| Jan. 10, 2014 | Updated datasheet to display respective page number on bottom left corner of every page |